

Technical Data Sheet

0402 Package Chip LED (0.2mm Height)

16-219A/B6C-ZN1P2TY/3T

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.
- The maximum height is 0.25mm

Descriptions

- The 16-219A SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc

Applications

- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General

Device Selection Guide

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Part No.	Material	Emitted Color	Resin Color
16-219A/B6C-ZN1P2TY/3T	InGaN	Blue	Water Clear

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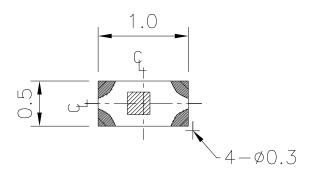
Device No.: DSE-0001844 Prepared date:25-Sep-2012 Prepared by: Jack Chiu Revision : 4 Release Date: 2012-10-01 13:47:11.0

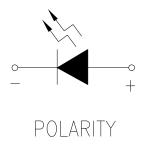
LifecyclePhase: **Expired Period: Forever**

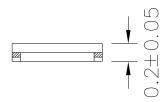
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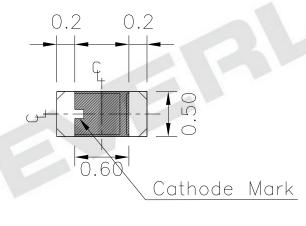
Package Outline Dimensions

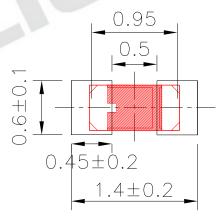






Recommend Soldering pac





Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

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Absolute Maximum Ratings (Ta=25)

Parameter	Symbol	Rating	Unit
Reverse Voltage	VR	5	V
Forward Current	I F	25	mA
Peak Forward Current (Duty 1/10 @1KHz)	IFP	100	mA
Power Dissipation	Pd	95	mW
Electrostatic Discharge(HBM)	ESD	150	V
Operating Temperature	Topr	-40 ~ +85	
Storage Temperature	Tstg	-40 ~ +90	
Soldering Temperature	Tsol	Reflow Soldering : 260 Hand Soldering : 350	for 10 sec.

Electro-Optical Characteristics (Ta=25)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	28.5	4	72.0	mcd	
Viewing Angle	2 1/2	-	120		deg	
Peak Wavelength	p		468		nm	IF=5mA
Dominant Wavelength	d	465		475	nm	
Forward Voltage	VF	2.6		3.0	V	
Reverse Current	IR			50	μA	V _R =5V

Notes:

1.Tolerance of Luminous Intensity ±11%

2. Tolerance of Dominant Wavelength ±1nm

3.Tolerance of Forward Voltage ±0.05V

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Bin Range Of Dom. Wavelength

Group	Bin	Min	Max	Unit	Condition
Z	X	465	470	T 7	
	Y	470	475	nm	IF=5mA

Bin Range Of Luminous Intensity

Bin	Min	Max	Unit	Condition	
N1	28.5	36.0			
N2	36.0	45.0	,	T 6 A	
P1	45.0	57.0	mcd	IF=5mA	
P2	57.0	72.0			

Bin Range Of Forward Voltage

Group	Bin	Min	Max	Unit	Condition	
Т	28	2.6	2.7			
	29	2.7	2.8	X	T 5 A	
	30	2.8	2.9	V	IF=5mA	
	31	2.9	3.0			

Notes:

1. Tolerance of Luminous Intensity ±11%

2. Tolerance of Dominant Wavelength ±1nm

3. Tolerance of Forward Voltage ±0.05V

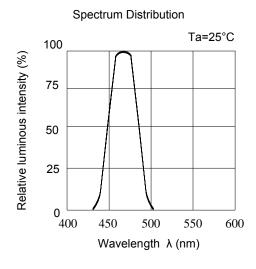
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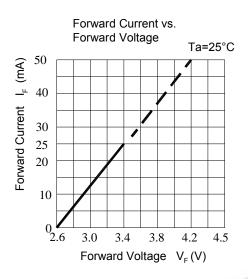
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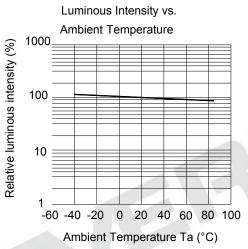
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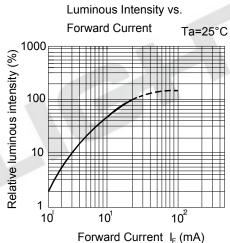


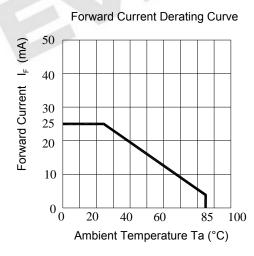
Typical Electro-Optical Characteristics Curves

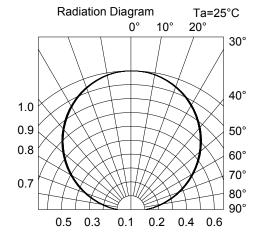












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LifecyclePhase: Approved Expired Period: Forever

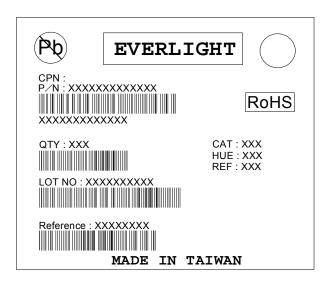


Label Explanation

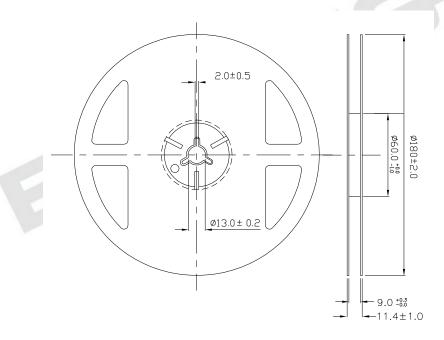
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

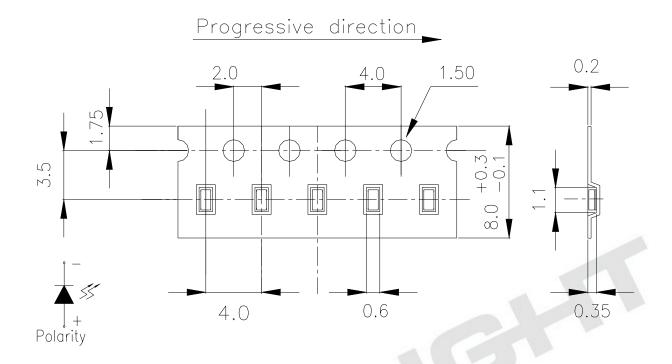
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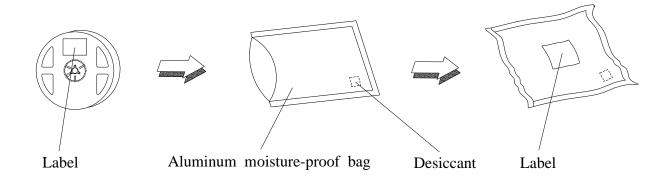


Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



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Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp.: 260 ±5 Max. 10sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H: +100 15min 5 min L: -40 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H: +100 5min 10 sec L: -10 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85 / 85%RH	1000 Hrs.	22 PCS.	0/1

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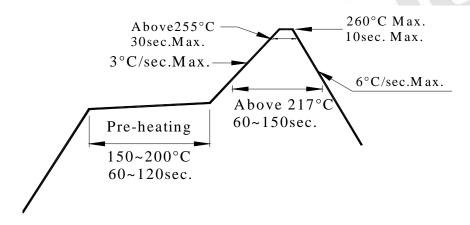
Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30 or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30 or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 60±5 for 24 hours.
- 3. Soldering Condition
 - 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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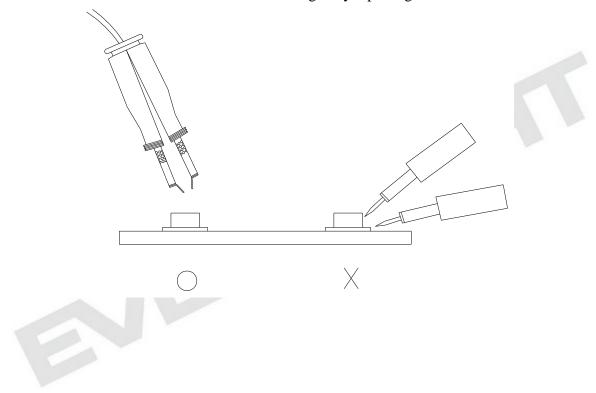


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350 for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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